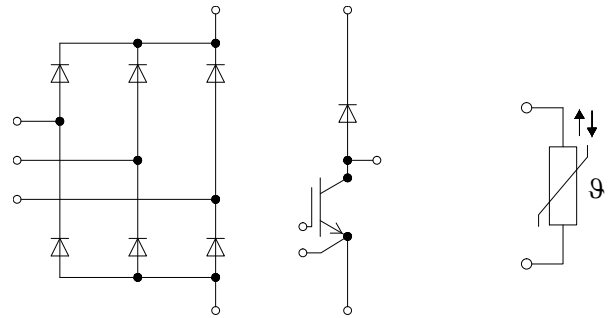
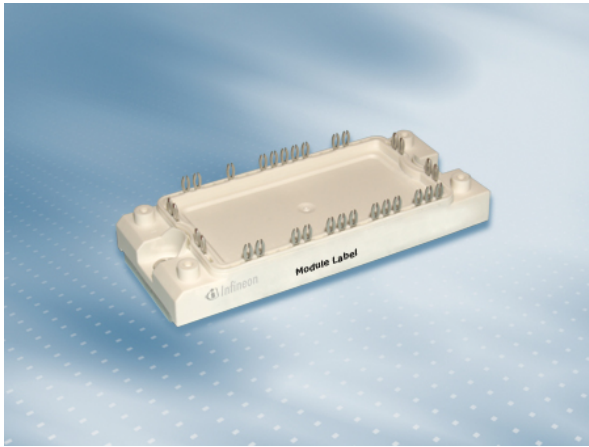


EconoPACK™2 模块 采用第四代沟槽栅/场终止IGBT4和第四代发射极控制二极管  
带有pressfit压接管脚和温度检测NTC

EconoPACK™2 module with Trench/Fieldstop IGBT4 and Emitter Controlled 4 diode and PressFIT / NTC



$V_{CES} = 1600V$   
 $I_{C\ nom} = 180A / I_{CRM} = 360A$

### 典型应用

- 辅助逆变器
- 空调
- 电机传动
- 伺服驱动器

### 电气特性

- $T_{vj\ op} = 150^{\circ}C$

### 机械特性

- 低热阻的三氧化二铝  $Al_2O_3$  衬底
- 高功率密度
- 绝缘的基板
- 紧凑型设计
- PressFIT 压接技术
- 符合RoHS
- 标准封装

### Typical Applications

- Auxiliary inverters
- Air conditioning
- Motor drives
- Servo drives

### Electrical Features

- $T_{vj\ op} = 150^{\circ}C$

### Mechanical Features

- $Al_2O_3$  substrate with low thermal resistance
- High power density
- Isolated base plate
- Compact design
- PressFIT contact technology
- RoHS compliant
- Standard housing

## Module Label Code

Barcode Code 128



DMX - Code



### Content of the Code

Content of the Code	Digit
Module Serial Number	1 - 5
Module Material Number	6 - 11
Production Order Number	12 - 19
Datecode (Production Year)	20 - 21
Datecode (Production Week)	22 - 23

## 二极管,整流器 / Diode, Rectifier

## 最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{RRM}$	1600	V
最大正向均方根电流(每芯片) Maximum RMS forward current per chip	$T_C = 100^{\circ}\text{C}$	$I_{FRMSM}$	150	A
最大整流器输出均方根电流 Maximum RMS current at rectifier output	$T_C = 100^{\circ}\text{C}$	$I_{RMSM}$	180	A
正向浪涌电流 Surge forward current	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$	$I_{FSM}$	1600 1400	A A
$I^2t$ -值 $I^2t$ - value	$t_p = 10\text{ ms}, T_{vj} = 25^{\circ}\text{C}$ $t_p = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$	$I^2t$	13000 9800	$\text{A}^2\text{s}$ $\text{A}^2\text{s}$

## 特征值 / Characteristic Values

		min.    typ.    max.			
正向电压 Forward voltage	$T_{vj} = 150^{\circ}\text{C}, I_F = 150\text{ A}$	$V_F$		1,20	V
阈值电压 Threshold voltage	$T_{vj} = 150^{\circ}\text{C}$	$V_{TO}$		0,83	V
斜率电阻 Slope resistance	$T_{vj} = 150^{\circ}\text{C}$	$r_T$		2,30	$\text{m}\Omega$
反向电流 Reverse current	$T_{vj} = 150^{\circ}\text{C}, V_R = 1600\text{ V}$	$I_R$		1,00	$\text{mA}$
结 - 外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode	$R_{thJC}$			0,330 K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个二极管 / per diode $\lambda_{\text{Paste}} = 1\text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1\text{ W}/(\text{m}\cdot\text{K})$	$R_{thCH}$		0,137	K/W
在开关状态下温度 Temperature under switching conditions		$T_{vj\text{ op}}$	-40		150 $^{\circ}\text{C}$

## IGBT, 制动-斩波器 / IGBT, Brake-Chopper

## 最大额定值 / Maximum Rated Values

集电极 - 发射极电压 Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	1200	V
连续集电极直流电流 Continuous DC collector current	$T_C = 95^{\circ}\text{C}, T_{vj\text{max}} = 175^{\circ}\text{C}$	$I_{C\text{nom}}$	100	A
集电极重复峰值电流 Repetitive peak collector current	$t_P = 1\text{ ms}$	$I_{CRM}$	200	A
栅极 - 发射极峰值电压 Gate-emitter peak voltage		$V_{GES}$	+/-20	V

## 特征值 / Characteristic Values

			min.	typ.	max.	
集电极 - 发射极饱和电压 Collector-emitter saturation voltage	$I_C = 100\text{ A}, V_{GE} = 15\text{ V}$ $I_C = 100\text{ A}, V_{GE} = 15\text{ V}$ $I_C = 100\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$V_{CE\text{sat}}$	1,75 2,05 2,10	2,10	V V V
栅极阈值电压 Gate threshold voltage	$I_C = 3,80\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		$V_{GEth}$	5,25	5,80	6,35 V
栅极电荷 Gate charge	$V_{GE} = -15\text{ V} \dots +15\text{ V}$		$Q_G$	0,75		$\mu\text{C}$
内部栅极电阻 Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		$R_{Gint}$	7,5		$\Omega$
输入电容 Input capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		$C_{ies}$	6,20		nF
反向传输电容 Reverse transfer capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		$C_{res}$	0,35		nF
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$		$I_{CES}$		1,0	mA
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$		$I_{GES}$		100	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	$I_C = 100\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Gon} = 1,6\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_{don}$	0,16 0,17 0,17		$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
上升时间(电感负载) Rise time, inductive load	$I_C = 100\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Gon} = 1,6\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_r$	0,03 0,04 0,04		$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
关断延迟时间(电感负载) Turn-off delay time, inductive load	$I_C = 100\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Goff} = 1,6\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_{doff}$	0,33 0,43 0,45		$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
下降时间(电感负载) Fall time, inductive load	$I_C = 100\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Goff} = 1,6\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$t_f$	0,08 0,145 0,17		$\mu\text{s}$ $\mu\text{s}$ $\mu\text{s}$
开通损耗能量(每脉冲) Turn-on energy loss per pulse	$I_C = 100\text{ A}, V_{CE} = 600\text{ V}, L_S = 30\text{ nH}$ $V_{GE} = \pm 15\text{ V}, di/dt = 3000\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Gon} = 1,6\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$E_{on}$	5,50 8,50 9,50		mJ mJ mJ
关断损耗能量(每脉冲) Turn-off energy loss per pulse	$I_C = 100\text{ A}, V_{CE} = 600\text{ V}, L_S = 30\text{ nH}$ $V_{GE} = \pm 15\text{ V}, du/dt = 3600\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Goff} = 1,6\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$E_{off}$	5,50 8,50 9,50		mJ mJ mJ
短路数据 SC data	$V_{GE} \leq 15\text{ V}, V_{CC} = 800\text{ V}$ $V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$ $t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$		$I_{SC}$	360		A
结 - 外壳热阻 Thermal resistance, junction to case	每个 IGBT / per IGBT		$R_{thJC}$		0,302	K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个 IGBT / per IGBT $\lambda_{\text{Paste}} = 1\text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1\text{ W}/(\text{m}\cdot\text{K})$		$R_{thCH}$	0,135		K/W
在开关状态下温度 Temperature under switching conditions			$T_{vj\text{op}}$	-40	150	$^{\circ}\text{C}$

## 二极管，制动-斩波器 / Diode, Brake-Chopper 最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{RRM}$	1200	V
连续正向直流电流 Continuous DC forward current		$I_F$	50	A
正向重复峰值电流 Repetitive peak forward current	$t_p = 1\text{ ms}$	$I_{FRM}$	100	A
$I^2t$ -值 $I^2t$ - value	$V_R = 0\text{ V}, t_p = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$	$I^2t$	510	$\text{A}^2\text{s}$

## 特征值 / Characteristic Values

		min.	typ.	max.	
正向电压 Forward voltage	$I_F = 50\text{ A}, V_{GE} = 0\text{ V}$ $I_F = 50\text{ A}, V_{GE} = 0\text{ V}$ $I_F = 50\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$V_F$	1,70 1,65 1,65	2,15 V V V
反向恢复峰值电流 Peak reverse recovery current	$I_F = 50\text{ A}, -di_F/dt = 2500\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 600\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$I_{RM}$	54,0 60,0 63,0	A A A
恢复电荷 Recovered charge	$I_F = 50\text{ A}, -di_F/dt = 2500\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 600\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$Q_r$	5,50 8,80 10,0	$\mu\text{C}$ $\mu\text{C}$ $\mu\text{C}$
反向恢复损耗 (每脉冲) Reverse recovery energy	$I_F = 50\text{ A}, -di_F/dt = 2500\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$ $V_R = 600\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$E_{rec}$	1,70 3,00 3,70	mJ mJ mJ
结 - 外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode		$R_{thJC}$		0,713 K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个二极管 / per diode $\lambda_{\text{Paste}} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1\text{ W}/(\text{m}\cdot\text{K})$		$R_{thCH}$	0,157	K/W
在开关状态下温度 Temperature under switching conditions			$T_{vj\text{ op}}$	-40	150 $^{\circ}\text{C}$

## 负温度系数热敏电阻 / NTC-Thermistor

### 特征值 / Characteristic Values

		min.	typ.	max.	
额定电阻值 Rated resistance	$T_{NTC} = 25^{\circ}\text{C}$	$R_{25}$	5,00		$\text{k}\Omega$
R100 偏差 Deviation of R100	$T_{NTC} = 100^{\circ}\text{C}, R_{100} = 493\ \Omega$	$\Delta R/R$	-5	5	%
耗散功率 Power dissipation	$T_{NTC} = 25^{\circ}\text{C}$	$P_{25}$		20,0	mW
B-值 B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/50}$	3375		K
B-值 B-value	$R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/80}$	3411		K
B-值 B-value	$R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/100}$	3433		K

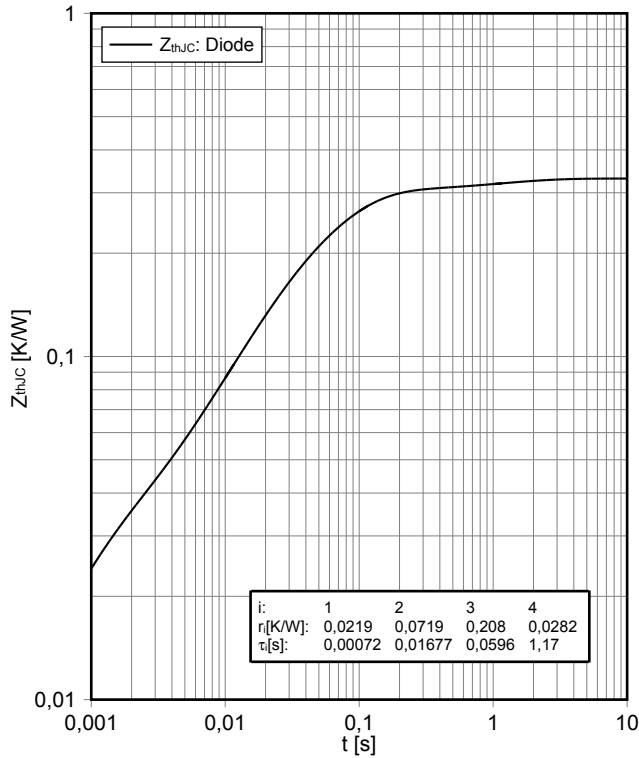
根据应用手册标定

Specification according to the valid application note.

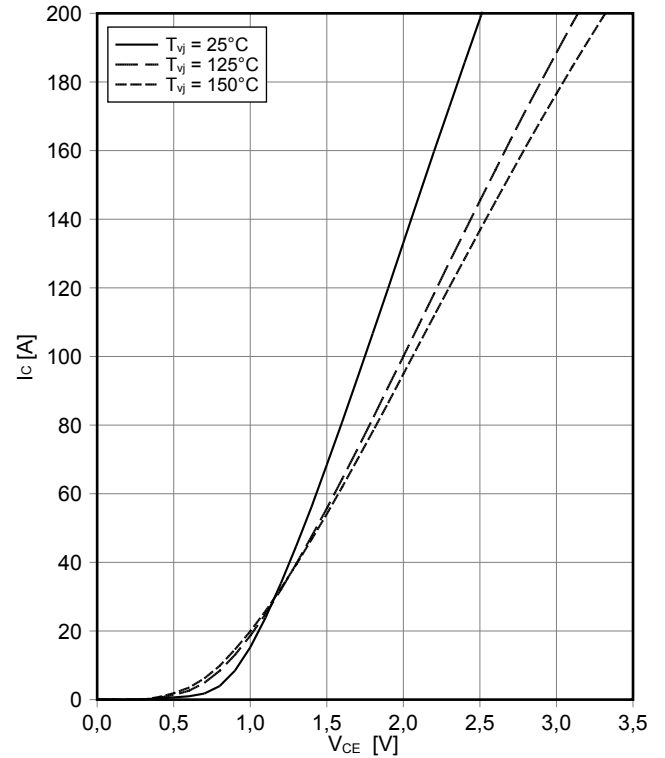
## 模块 / Module

绝缘测试电压 Isolation test voltage	RMS, f = 50 Hz, t = 1 min.	V <sub>ISOL</sub>	2,5		kV
模块基板材料 Material of module baseplate			Cu		
内部绝缘 Internal isolation	基本绝缘 (class 1, IEC 61140) basic insulation (class 1, IEC 61140)		Al <sub>2</sub> O <sub>3</sub>		
爬电距离 Creepage distance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal		10,0		mm
电气间隙 Clearance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal		7,5		mm
相对电痕指数 Comperative tracking index		CTI	> 200		
min.    typ.    max.					
杂散电感, 模块 Stray inductance module		L <sub>sCE</sub>		50	nH
模块引线电阻, 端子-芯片 Module lead resistance, terminals - chip	T <sub>c</sub> = 25°C, 每个开关 / per switch	R <sub>AA'+CC'</sub>		1,30	mΩ
储存温度 Storage temperature		T <sub>stg</sub>	-40	125	°C
模块安装的安装扭矩 Mounting torque for modul mounting	螺丝 M5 根据相应的应用手册进行安装 Screw M5 - Mounting according to valid application note	M	3,00	6,00	Nm
重量 Weight		G		180	g

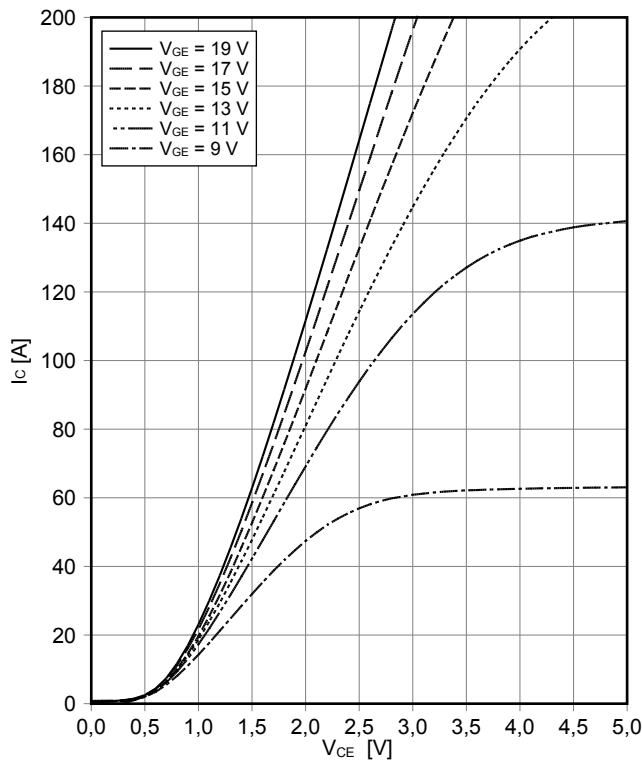
瞬态热阻抗 二极管,整流器  
**transient thermal impedance Diode, Rectifier**  
 $Z_{thJC} = f(t)$



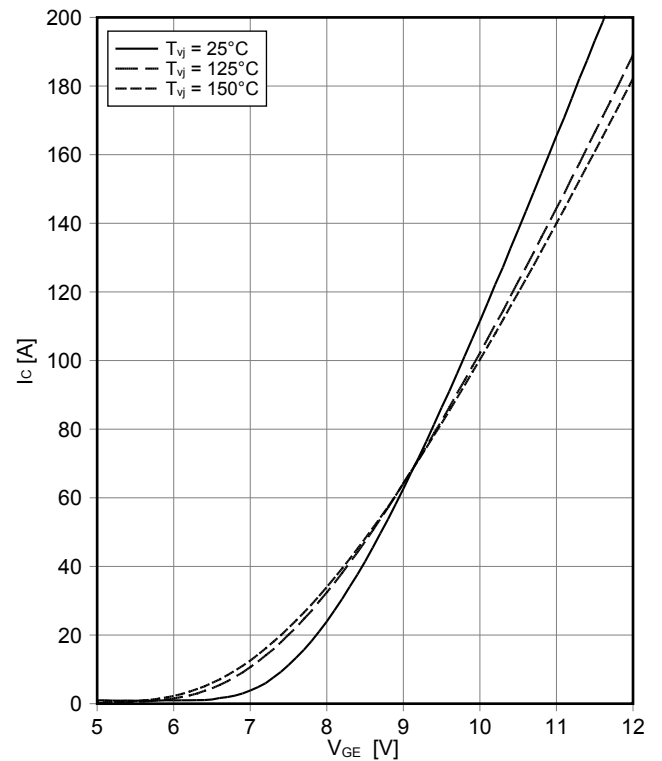
输出特性 IGBT, 制动-斩波器 (典型)  
**output characteristic IGBT, Brake-Chopper (typical)**  
 $I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



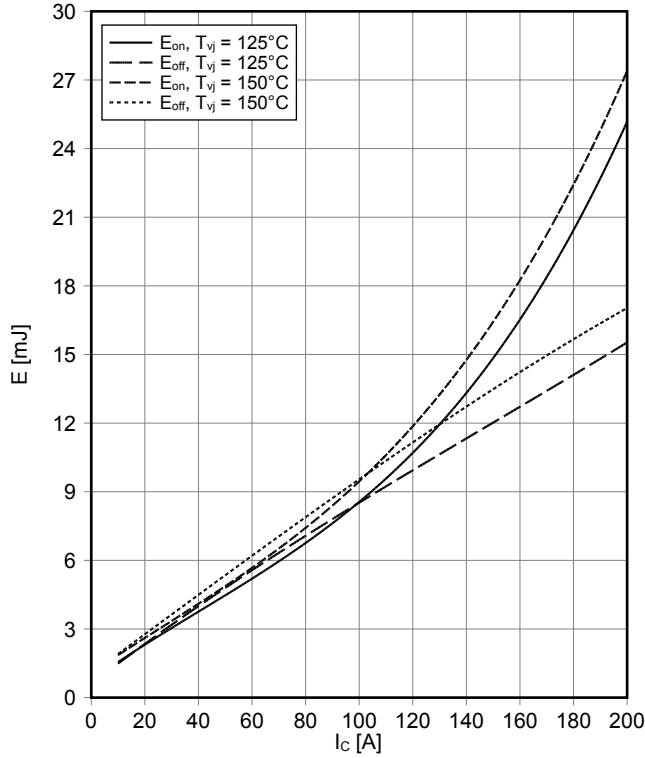
输出特性 IGBT, 制动-斩波器 (典型)  
**output characteristic IGBT, Brake-Chopper (typical)**  
 $I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



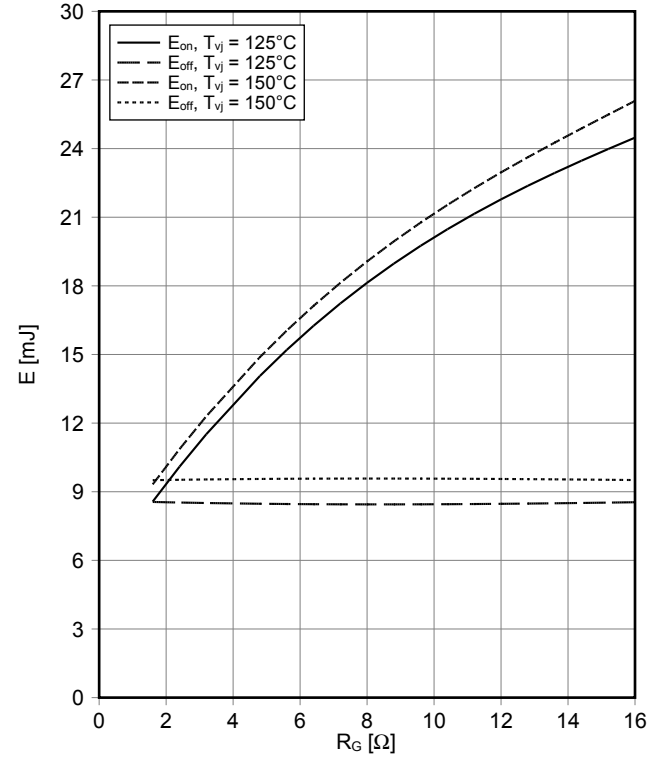
传输特性 IGBT, 制动-斩波器 (典型)  
**transfer characteristic IGBT, Brake-Chopper (typical)**  
 $I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



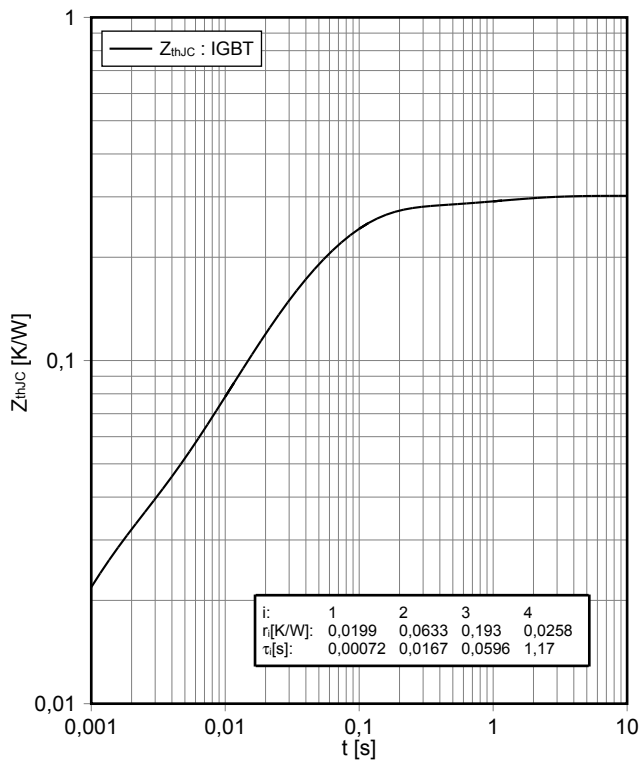
开关损耗 IGBT, 制动-斩波器 (典型)  
**switching losses IGBT, Brake-Chopper (typical)**  
 $E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Gon} = 1.6\ \Omega$ ,  $R_{Goff} = 1.6\ \Omega$ ,  $V_{CE} = 600\text{ V}$



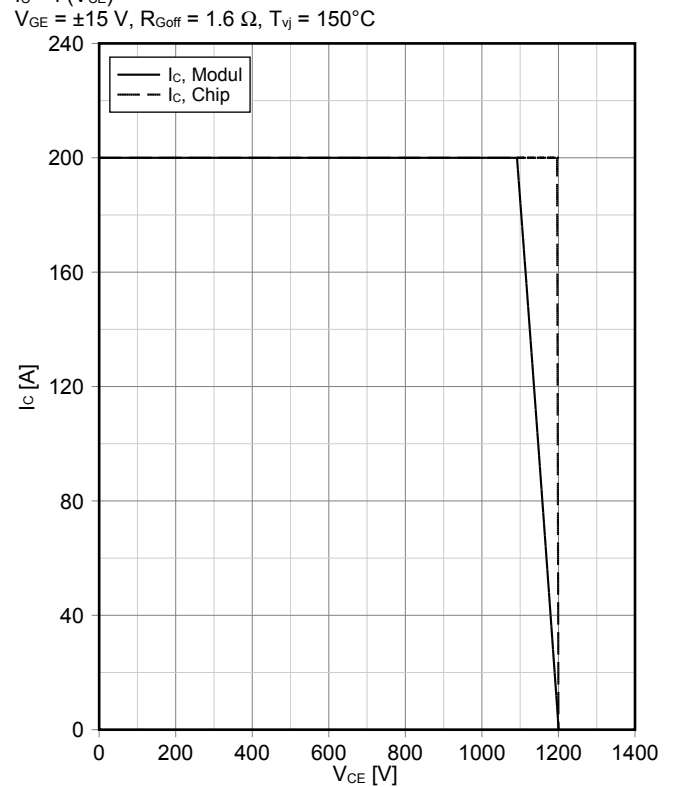
开关损耗 IGBT, 制动-斩波器 (典型)  
**switching losses IGBT, Brake-Chopper (typical)**  
 $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 100\text{ A}$ ,  $V_{CE} = 600\text{ V}$



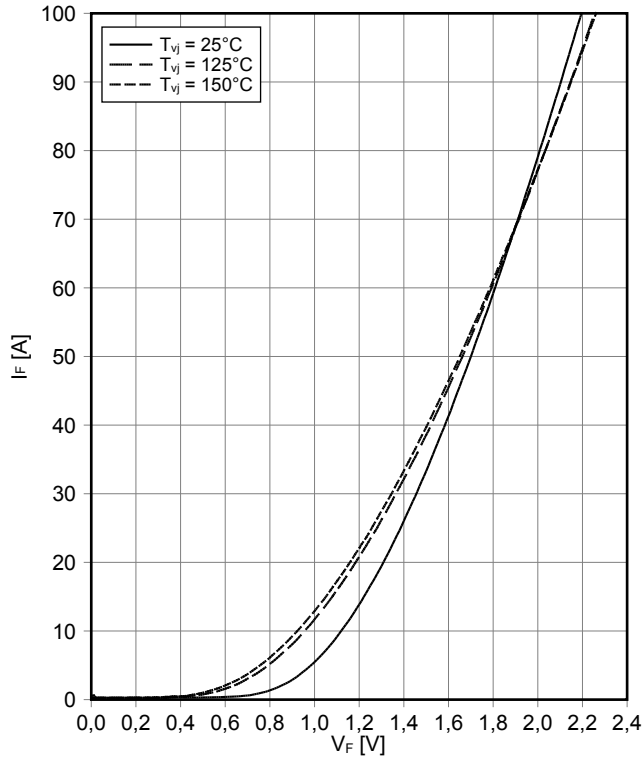
瞬态热阻抗 IGBT, 制动-斩波器  
**transient thermal impedance IGBT, Brake-Chopper**  
 $Z_{thJC} = f(t)$



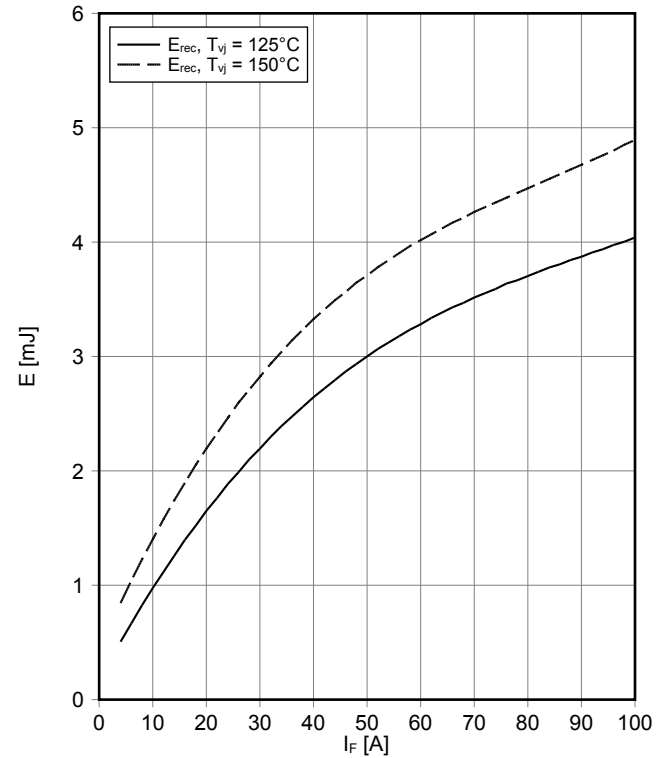
反偏安全工作区 IGBT, 制动-斩波器 (RBSOA)  
**reverse bias safe operating area IGBT, Brake-Chopper (RBSOA)**  
 $I_C = f(V_{CE})$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Goff} = 1.6\ \Omega$ ,  $T_{vj} = 150^\circ\text{C}$



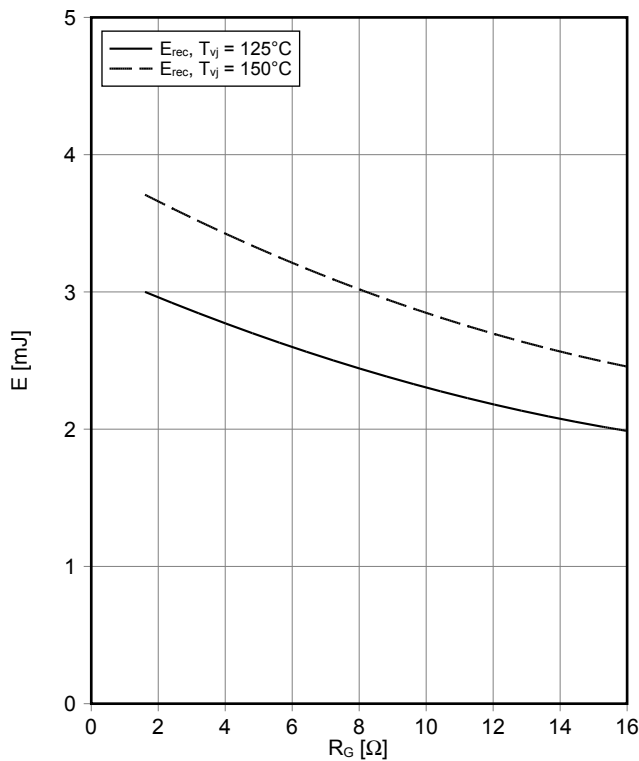
正向偏压特性 二极管, 制动-斩波器 (典型)  
**forward characteristic of Diode, Brake-Chopper (typical)**  
 $I_F = f(V_F)$



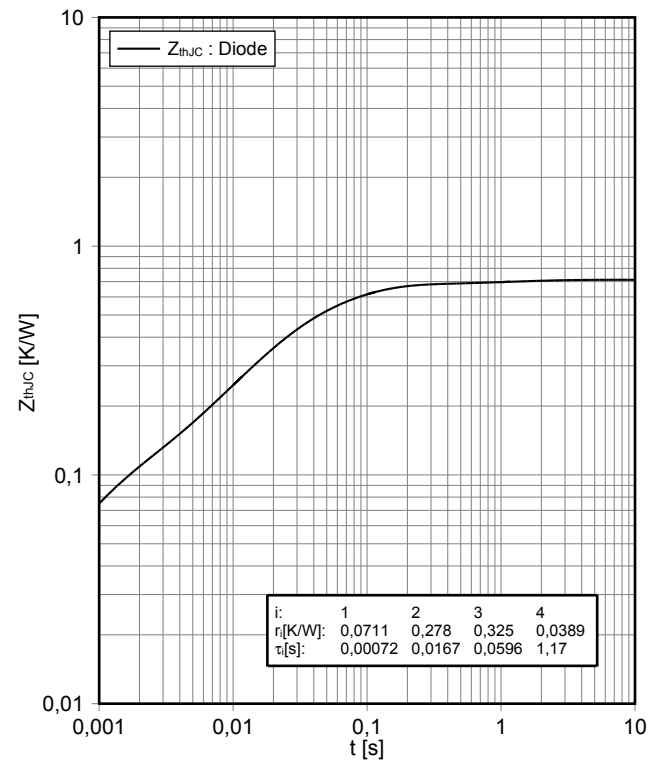
开关损耗 二极管, 制动-斩波器 (典型)  
**switching losses Diode, Brake-Chopper (typical)**  
 $E_{rec} = f(I_F)$   
 $R_{Gon} = 1.6 \Omega, V_{CE} = 600 \text{ V}$



开关损耗 二极管, 制动-斩波器 (典型)  
**switching losses Diode, Brake-Chopper (typical)**  
 $E_{rec} = f(R_G)$   
 $I_F = 50 \text{ A}, V_{CE} = 600 \text{ V}$



瞬态热阻抗 二极管, 制动-斩波器  
**transient thermal impedance Diode, Brake-Chopper**  
 $Z_{thJC} = f(t)$

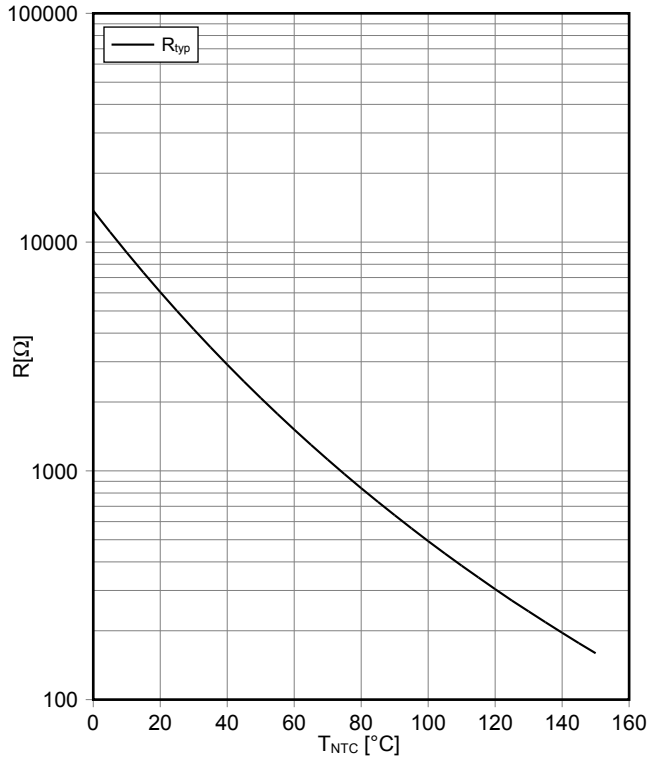




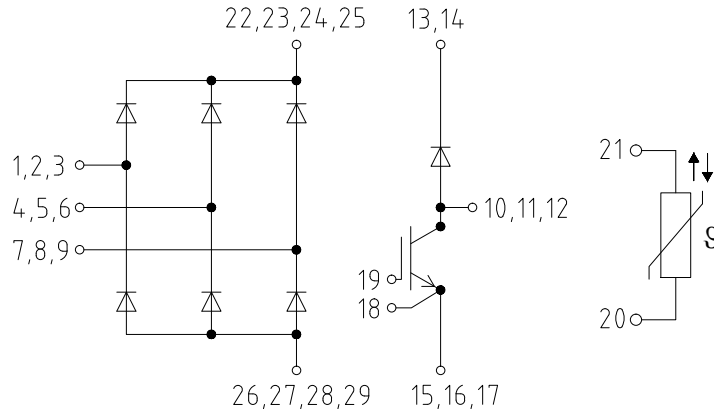
负温度系数热敏电阻 温度特性

**NTC-Thermistor-temperature characteristic (typical)**

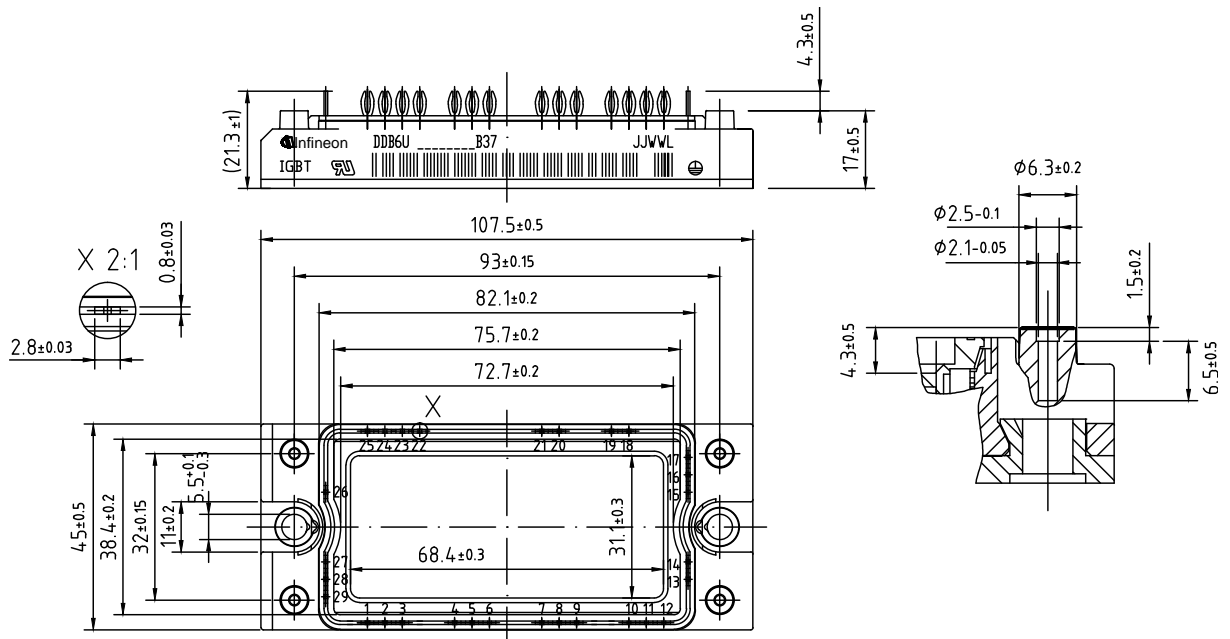
$R = f(T)$



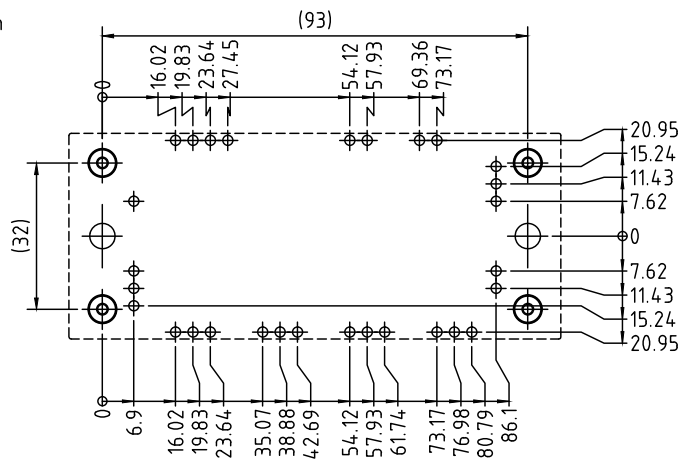
## 接线图 / Circuit diagram



## 封装尺寸 / Package outlines



## PCB hole pattern



- Tolerance of PCB hole pattern  $\pm \phi 0.1$
- hole specifications see AN 2007-09
- Diameters of plated holes  $\phi 2.14\text{mm} - 2.29\text{mm}$
- Diameter of drill  $\phi 2.35\text{mm}$

#### Trademarks

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Edition 2017-07-25

Published by  
Infineon Technologies AG  
81726 München, Germany

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